

PATENT

IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of: Masanao Hori
Appl. No.: Conf.:
Filed: August 13, 2003 Group:
Title: FABRICATION METHOD FOR A SEMICONDUCTOR
CSP TYPE PACKAGE Examiner:

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

August 13, 2003

Sir:

The following preliminary amendments and remarks are respectfully submitted in connection with the above-identified application.

Amendments to the Specification begin on page 2 of this paper.

Remarks begin on page 3 of this paper.

An **Appendix** is attached following the signature page of this paper.